

ABSTRACT

It is to provide an electronic component packaging container excellent in mechanical strength.

- An electronic component packaging container which
- 5 comprises a multilayer polyester sheet having a base layer comprising a polyethylene terephthalate type resin and a polycarbonate type resin and a surface layer comprising a polycarbonate type resin, formed on at least one side of the base layer, wherein the base layer
- 10 contains from 70 to 97 wt% of the polyethylene terephthalate type resin and from 3 to 30 wt% of the polycarbonate type resin based on the total amount of the polyethylene terephthalate type resin and the polycarbonate type resin, and the thickness of the
- 15 surface layer is from 10 to 30% of the total thickness.

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